

## TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

ETAS ID: TM679889

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	SECURITY INTEREST		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
FAST RADIUS, INC.		09/10/2021	Corporation: DELAWARE
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	SVB INNOVATION CREDIT FUND VIII, L.P.		
<b>Street Address:</b>	2770 SAND HILL RD		
<b>City:</b>	MENLO PARK		
<b>State/Country:</b>	CALIFORNIA		
<b>Postal Code:</b>	94025		
<b>Entity Type:</b>	Limited Partnership: DELAWARE		
<b>PROPERTY NUMBERS Total: 9</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Serial Number:</b>	90585006	CLOUD MANUFACTURING PLATFORM	
<b>Serial Number:</b>	90853108	THE MAKE COMPANY	
<b>Registration Number:</b>	5722400	ALP	
<b>Registration Number:</b>	5922160	APPLICATION LAUNCH PROGRAM (ALP)	
<b>Registration Number:</b>	5269129	FAST RADIUS	
<b>Registration Number:</b>	5722225	FR	
<b>Registration Number:</b>	5907012	MAKE NEW THINGS POSSIBLE	
<b>Registration Number:</b>	6008464	TOTAL VALUE OF ADDITIVE (TVA)	
<b>Registration Number:</b>	5694773	TVA	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>	2063599000		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
<b>Phone:</b>	2063598000		
<b>Email:</b>	pctrademarks@perkinscoie.com		
<b>Correspondent Name:</b>	Stefan Blum		
<b>Address Line 1:</b>	PERKINS COIE LLP, P.O. Box 2608		
<b>Address Line 4:</b>	Seattle, WASHINGTON 98111		
<b>ATTORNEY DOCKET NUMBER:</b>	141721-0126		

OP \$240.00 90585006

<b>NAME OF SUBMITTER:</b>	Stefan B. Blum
<b>SIGNATURE:</b>	/Stefan B. Blum/
<b>DATE SIGNED:</b>	10/08/2021
<b>Total Attachments: 8</b> source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page1.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page2.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page3.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page4.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page5.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page6.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page7.tif source=SVB Capital_Fast Radius - IP Security Agreement_Borrower#page8.tif	

## INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement (“**Agreement**”) is entered into as of September 10, 2021 by and between SVB INNOVATION CREDIT FUND VIII, L.P., a Delaware limited partnership (“**Lender**”) and FAST RADIUS, INC., a Delaware corporation (“**Grantor**”) whose address is 113 N May St., Chicago, IL 60607.

### RECITALS

A. Lender has agreed to make certain advances of money and to extend certain financial accommodation to Grantor (the “**Loans**”) in the amounts and manner set forth in that certain Loan and Security Agreement by and between Lender and Grantor dated as of the date hereof (as the same may be amended, modified or supplemented from time to time, the “**Loan Agreement**”); capitalized terms used herein are used as defined in the Loan Agreement).

B. Pursuant to the terms of the Loan Agreement, Grantor has agreed to grant to Lender a security interest in all of Grantor’s right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral. Lender is willing to enter into the Loan Agreement, but only upon the condition, among others, that Grantor shall grant to Lender a security interest in certain Copyrights, Trademarks, Patents, and Mask Works (as each term is described below) to secure the obligations of Grantor under the Loan Agreement.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Loan Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

### AGREEMENT

1. **Grant of Security Interest.** To secure its obligations under the Loan Agreement, Grantor grants and pledges to Lender a security interest in all of Grantor's right, title and interest in, to and under its intellectual property (all of which shall collectively be called the “**Intellectual Property Collateral**”), including, without limitation, the following:

(a) Any and all copyright rights, copyright applications, copyright registrations and like protections in each work or authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the “**Copyrights**”);

(b) Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;

(c) Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

(d) All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the “**Patents**”);

(e) Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the "**Trademarks**");

(f) All mask works or similar rights available for the protection of semiconductor chips, now owned or hereafter acquired, including, without limitation those set forth on Exhibit D attached hereto (collectively, the "**Mask Works**");

(g) Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

(h) All licenses or other rights to use any of the Copyrights, Patents, Trademarks, or Mask Works and all license fees and royalties arising from such use to the extent permitted by such license or rights;

(i) All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, Patents, or Mask Works; and

(j) All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

Notwithstanding the foregoing, the Intellectual Property Collateral does not include any "intent-to-use" trademarks at all times prior to the first use thereof, whether by the actual use thereof in commerce, the recording of a statement of use with the United States Patent and Trademark Office or otherwise, but only to the extent the granting of a security interest in such "intent-to-use" trademarks would be contrary to applicable law.

2. Recordation. Grantor authorizes the Commissioner for Patents, the Commissioner for Trademarks and the Register of Copyrights and any other government officials to record and register this Agreement upon request by Lender.

3. Authorization. Grantor hereby authorizes Lender to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property Collateral which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new Intellectual Property Collateral.

4. Loan Documents. This Agreement has been entered into pursuant to and in conjunction with the Loan Agreement, which is hereby incorporated by reference. The provisions of the Loan Agreement shall supersede and control over any conflicting or inconsistent provision herein. The rights and remedies of Lender with respect to the Intellectual Property Collateral are as provided by the Loan Agreement and related documents, and nothing in this Agreement shall be deemed to limit such rights and remedies.

5. Execution in Counterparts. This Agreement may be executed in counterparts (and by different parties hereto in different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or in electronic (i.e., "pdf" or "tif" format) shall be effective as delivery of a manually executed counterpart of this Agreement.

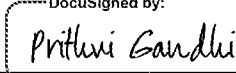
6. Successors and Assigns. This Agreement will be binding on and shall inure to the benefit of the parties hereto and their respective successors and assigns.

7. Governing Law. This Agreement and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Agreement and the transactions contemplated hereby and thereby shall be governed by, and construed in accordance with, the laws of the United States and the State of California, without giving effect to any choice or conflict of law provision or rule (whether of the State of California or any other jurisdiction).

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

**GRANTOR:**

FAST RADIUS, INC.

DocuSigned by:  
  
Signature: \_\_\_\_\_  
Print Name: Prithvi Gandhi  
Title: Chief Financial Officer

**LENDER:**

**SVB INNOVATION CREDIT FUND VIII, L.P.**

**By: SVB Innovation Credit Partners VIII, LLC,  
a Delaware limited liability company, its General  
Partner**

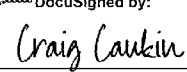
DocuSigned by:  
  
Signature: \_\_\_\_\_  
Print Name: Craig Caukin  
Title: Senior Managing Director

EXHIBIT A

Copyrights

Description

Registration/  
Application  
Number

Registration/  
Application  
Date

None.

EXHIBIT B

Patents

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
MANUFACTURING AND DEVELOPMENT PLATFORM	63/134,661	1/1/2021
MANUFACTURING A PRODUCT DESIGN	63/197,683	6/1/2021
MANUFACTURING AND DEVELOPMENT PLATFORM	17/461,148	8/1/2021
MANUFACTURING AND DEVELOPMENT PLATFORM	17/460,934	8/1/2021
MANUFACTURING AND DEVELOPMENT PLATFORM	17/461,058	8/1/2021



EXHIBIT C

Trademarks

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
CLOUD MANUFACTURING PLATFORM	90/585006	3/17/2021
THE MAKE COMPANY	90/853,108	7/28/2021
ALP	5722400	4/9/2019
APPLICATION LAUNCH PROGRAM (ALP)	5922160	11/26/2019
FAST RADIUS	5269129	8/22/2017
FR and Design	5722225	4/9/2019
MAKE NEW THINGS POSSIBLE	5907012	11/12/2019
TOTAL VALUE OF ADDITIVE (TVA)	6008464	3/10/2020
TVA	5694773	3/12/2019

EXHIBIT D

Mask Works

Description

Registration/  
Application  
Number

Registration/  
Application  
Date

None.